

# MOTOROLA

## SEMICONDUCTOR

### TECHNICAL DATA

T-66-21-55

## 1-of-8 Decoder/Demultiplexer

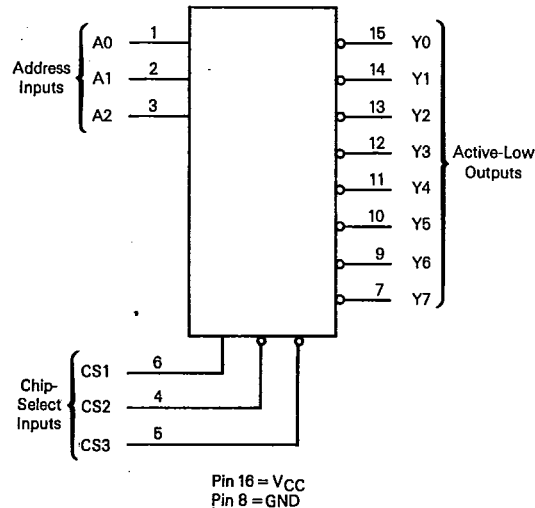
### High-Performance Silicon-Gate CMOS

The MC54/74HC138 is identical in pinout to the LS138. The device inputs are compatible with standard CMOS outputs; with pullup resistors, they are compatible with LSTTL outputs.

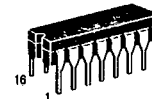
The HC138 decodes a three-bit Address to one-of-eight active-low outputs. This device features three Chip Select inputs, two active-low and one active-high to facilitate the demultiplexing, cascading, and chip-selecting functions. The demultiplexing function is accomplished by using the Address inputs to select the desired device output; one of the Chip Selects is used as a data input while the other Chip Selects are held in their active states.

- Output Drive Capability: 10 LSTTL Loads
- Outputs Directly Interface to CMOS, NMOS, and TTL
- Operating Voltage Range: 2 to 6 V
- Low Input Current: 1  $\mu$ A
- High Noise Immunity Characteristic of CMOS Devices
- In Compliance with the Requirements Defined by JEDEC Standard No. 7A
- Chip Complexity: 116 FETs or 29 Equivalent Gates

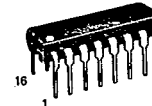
LOGIC DIAGRAM



## MC54/74HC138



J SUFFIX  
CERAMIC  
CASE 620-09



N SUFFIX  
PLASTIC  
CASE 648-06



D SUFFIX  
SOIC  
CASE 751B-03

### ORDERING INFORMATION

|            |         |
|------------|---------|
| MC74HCXXXN | Plastic |
| MC54HCXXXJ | Ceramic |
| MC74HCXXXD | SOIC    |

$T_A = -55^\circ$  to  $125^\circ\text{C}$  for all packages.  
Dimensions in Chapter 7.

PIN ASSIGNMENT

|     |   |    |     |
|-----|---|----|-----|
| A0  | 1 | 16 | VCC |
| A1  | 2 | 15 | Y0  |
| A2  | 3 | 14 | Y1  |
| CS2 | 4 | 13 | Y2  |
| CS3 | 5 | 12 | Y3  |
| CS1 | 6 | 11 | Y4  |
| Y7  | 7 | 10 | Y5  |
| GND | 8 | 9  | Y6  |

FUNCTION TABLE

| Inputs |     |     |    |    |    | Outputs |    |    |    |    |    |    |    |
|--------|-----|-----|----|----|----|---------|----|----|----|----|----|----|----|
| CS1    | CS2 | CS3 | A2 | A1 | A0 | Y0      | Y1 | Y2 | Y3 | Y4 | Y5 | Y6 | Y7 |
| X      | X   | H   | X  | X  | X  | H       | H  | H  | H  | H  | H  | H  | H  |
| X      | H   | X   | X  | X  | X  | H       | H  | H  | H  | H  | H  | H  | H  |
| L      | X   | X   | X  | X  | X  | H       | H  | H  | H  | H  | H  | H  | H  |
| H      | L   | L   | L  | L  | L  | L       | H  | H  | H  | H  | H  | H  | H  |
| H      | L   | L   | L  | L  | H  | H       | L  | H  | H  | H  | H  | H  | H  |
| H      | L   | L   | L  | H  | L  | H       | H  | L  | H  | H  | H  | H  | H  |
| H      | L   | L   | L  | H  | H  | H       | H  | L  | L  | H  | H  | H  | H  |
| H      | L   | L   | H  | L  | L  | H       | H  | H  | H  | L  | L  | H  | H  |
| H      | L   | L   | H  | L  | H  | H       | H  | H  | H  | H  | L  | L  | H  |
| H      | L   | L   | H  | H  | L  | H       | H  | H  | H  | H  | H  | L  | L  |
| H      | L   | L   | H  | H  | H  | H       | H  | H  | H  | H  | H  | H  | L  |

H = high level (steady state)

L = low level (steady state)

X = don't care

## MC54/74HC138

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## MAXIMUM RATINGS\*

| Symbol           | Parameter                                                                                         | Value                        | Unit |
|------------------|---------------------------------------------------------------------------------------------------|------------------------------|------|
| V <sub>CC</sub>  | DC Supply Voltage (Referenced to GND)                                                             | -0.5 to +7.0                 | V    |
| V <sub>in</sub>  | DC Input Voltage (Referenced to GND)                                                              | -1.5 to V <sub>CC</sub> +1.5 | V    |
| V <sub>out</sub> | DC Output Voltage (Referenced to GND)                                                             | -0.5 to V <sub>CC</sub> +0.5 | V    |
| I <sub>in</sub>  | DC Input Current, per Pin                                                                         | ±20                          | mA   |
| I <sub>out</sub> | DC Output Current, per Pin                                                                        | ±25                          | mA   |
| I <sub>CC</sub>  | DC Supply Current, V <sub>CC</sub> and GND Pins                                                   | ±50                          | mA   |
| P <sub>D</sub>   | Power Dissipation in Still Air, Plastic or Ceramic DIP†<br>SOIC Package†                          | 750<br>500                   | mW   |
| T <sub>stg</sub> | Storage Temperature                                                                               | -65 to +160                  | °C   |
| T <sub>L</sub>   | Lead Temperature, 1 mm from Case for 10 Seconds<br>(Plastic DIP or SOIC Package)<br>(Ceramic DIP) | 260<br>300                   | °C   |

This device contains protection circuitry to guard against damage due to high static voltages or electric fields. However, precautions must be taken to avoid applications of any voltage higher than maximum rated voltages to this high-impedance circuit. For proper operation, V<sub>in</sub> and V<sub>out</sub> should be constrained to the range GND ≤ (V<sub>in</sub> or V<sub>out</sub>) ≤ V<sub>CC</sub>. Unused inputs must always be tied to an appropriate logic voltage level (e.g., either GND or V<sub>CC</sub>). Unused outputs must be left open.

\*Maximum Ratings are those values beyond which damage to the device may occur. Functional operation should be restricted to the Recommended Operating Conditions.

†Derating — Plastic DIP: -10 mW/°C from 65° to 125°C  
Ceramic DIP: -10 mW/°C from 100° to 125°C  
SOIC Package: -7 mW/°C from 65° to 125°C

For high frequency or heavy load considerations, see Chapter 4.

## RECOMMENDED OPERATING CONDITIONS

| Symbol                             | Parameter                                            | Min                                                                        | Max             | Unit               |    |
|------------------------------------|------------------------------------------------------|----------------------------------------------------------------------------|-----------------|--------------------|----|
| V <sub>CC</sub>                    | DC Supply Voltage (Referenced to GND)                | 2.0                                                                        | 6.0             | V                  |    |
| V <sub>in</sub> , V <sub>out</sub> | DC Input Voltage, Output Voltage (Referenced to GND) | 0                                                                          | V <sub>CC</sub> | V                  |    |
| T <sub>A</sub>                     | Operating Temperature, All Package Types             | -55                                                                        | +125            | °C                 |    |
| t <sub>r</sub> , t <sub>f</sub>    | Input Rise and Fall Time<br>(Figure 2)               | V <sub>CC</sub> =2.0 V<br>V <sub>CC</sub> =4.5 V<br>V <sub>CC</sub> =6.0 V | 0<br>0<br>0     | 1000<br>500<br>400 | ns |

## DC ELECTRICAL CHARACTERISTICS (Voltages Referenced to GND)

| Symbol          | Parameter                                      | Test Conditions                                                                                                     | V <sub>CC</sub><br>V | Guaranteed Limit   |                    |                    | Unit |
|-----------------|------------------------------------------------|---------------------------------------------------------------------------------------------------------------------|----------------------|--------------------|--------------------|--------------------|------|
|                 |                                                |                                                                                                                     |                      | 25°C to<br>-55°C   | ≤85°C              | ≤125°C             |      |
| V <sub>IH</sub> | Minimum High-Level Input Voltage               | V <sub>out</sub> =0.1 V or V <sub>CC</sub> -0.1 V<br> I <sub>out</sub>   ≤ 20 μA                                    | 2.0<br>4.5<br>6.0    | 1.5<br>3.15<br>4.2 | 1.5<br>3.15<br>4.2 | 1.5<br>3.15<br>4.2 | V    |
| V <sub>IL</sub> | Maximum Low-Level Input Voltage                | V <sub>out</sub> =0.1 V or V <sub>CC</sub> -0.1 V<br> I <sub>out</sub>   ≤ 20 μA                                    | 2.0<br>4.5<br>6.0    | 0.3<br>0.9<br>1.2  | 0.3<br>0.9<br>1.2  | 0.3<br>0.9<br>1.2  | V    |
| V <sub>OH</sub> | Minimum High-Level Output Voltage              | V <sub>in</sub> =V <sub>IH</sub> or V <sub>IL</sub><br> I <sub>out</sub>   ≤ 20 μA                                  | 2.0<br>4.5<br>6.0    | 1.9<br>4.4<br>5.9  | 1.9<br>4.4<br>5.9  | 1.9<br>4.4<br>5.9  | V    |
|                 |                                                | V <sub>in</sub> =V <sub>IH</sub> or V <sub>IL</sub><br> I <sub>out</sub>   ≤ 4.0 mA<br> I <sub>out</sub>   ≤ 5.2 mA | 4.5<br>6.0           | 3.98<br>5.48       | 3.84<br>5.34       | 3.70<br>5.20       | V    |
| V <sub>OL</sub> | Maximum Low-Level Output Voltage               | V <sub>in</sub> =V <sub>IH</sub> or V <sub>IL</sub><br> I <sub>out</sub>   ≤ 20 μA                                  | 2.0<br>4.5<br>6.0    | 0.1<br>0.1<br>0.1  | 0.1<br>0.1<br>0.1  | 0.1<br>0.1<br>0.1  | V    |
|                 |                                                | V <sub>in</sub> =V <sub>IH</sub> or V <sub>IL</sub><br> I <sub>out</sub>   ≤ 4.0 mA<br> I <sub>out</sub>   ≤ 5.2 mA | 4.5<br>6.0           | 0.26<br>0.26       | 0.33<br>0.33       | 0.40<br>0.40       | V    |
| I <sub>in</sub> | Maximum Input Leakage Current                  | V <sub>in</sub> =V <sub>CC</sub> or GND                                                                             | 6.0                  | ±0.1               | ±1.0               | ±1.0               | μA   |
| I <sub>CC</sub> | Maximum Quiescent Supply Current (per Package) | V <sub>in</sub> =V <sub>CC</sub> or GND<br>I <sub>out</sub> =0 μA                                                   | 6.0                  | 8                  | 80                 | 160                | μA   |

NOTE: Information on typical parametric values can be found in Chapter 4.

## MC54/74HC138

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AC ELECTRICAL CHARACTERISTICS ( $C_L = 50$  pF, Input  $t_r = t_f = 6$  ns)

| Symbol             | Parameter                                                              | VCC<br>V | Guaranteed Limit |       |        | Unit |
|--------------------|------------------------------------------------------------------------|----------|------------------|-------|--------|------|
|                    |                                                                        |          | 25°C to<br>-55°C | ≤85°C | ≤125°C |      |
| $t_{PLH}$          | Maximum Propagation Delay, Input A to Output Y<br>(Figures 1 and 4)    | 2.0      | 150              | 190   | 225    | ns   |
|                    |                                                                        | 4.5      | 30               | 38    | 45     |      |
|                    |                                                                        | 6.0      | 26               | 33    | 38     |      |
| $t_{PHL}$          |                                                                        | 2.0      | 200              | 250   | 300    |      |
|                    |                                                                        | 4.5      | 40               | 50    | 60     |      |
|                    |                                                                        | 6.0      | 34               | 43    | 51     |      |
| $t_{PLH}, t_{PHL}$ | Maximum Propagation Delay, CS1 to Output Y<br>(Figures 2 and 4)        | 2.0      | 150              | 190   | 225    | ns   |
|                    |                                                                        | 4.5      | 30               | 38    | 45     |      |
|                    |                                                                        | 6.0      | 26               | 33    | 38     |      |
| $t_{PLH}$          | Maximum Propagation Delay, CS2 or CS3 to Output Y<br>(Figures 3 and 4) | 2.0      | 150              | 190   | 225    | ns   |
|                    |                                                                        | 4.5      | 30               | 38    | 45     |      |
|                    |                                                                        | 6.0      | 26               | 33    | 38     |      |
| $t_{PHL}$          |                                                                        | 2.0      | 175              | 220   | 265    |      |
|                    |                                                                        | 4.5      | 35               | 44    | 53     |      |
|                    |                                                                        | 6.0      | 30               | 37    | 45     |      |
| $t_{TLH}, t_{THL}$ | Maximum Output Transition Time, Any Output<br>(Figures 2 and 4)        | 2.0      | 75               | 95    | 110    | ns   |
|                    |                                                                        | 4.5      | 15               | 19    | 22     |      |
|                    |                                                                        | 6.0      | 13               | 16    | 19     |      |
| $C_{in}$           | Maximum Input Capacitance                                              | —        | 10               | 10    | 10     | pF   |

## NOTES:

1. For propagation delays with loads other than 50 pF, see Chapter 4.
2. Information on typical parametric values can be found in Chapter 4.

|     |                                                                                                                                                                                                    |                                  |    |
|-----|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|----------------------------------|----|
| CPD | Power Dissipation Capacitance (Per Package)<br>Used to determine the no-load dynamic power consumption:<br>$P_D = CPD \cdot V_{CC}^2 f + I_{CC} V_{CC}$<br>For load considerations, see Chapter 4. | Typical @ 25°C, $V_{CC} = 5.0$ V | pF |
|     |                                                                                                                                                                                                    | 55                               |    |

## SWITCHING WAVEFORMS

FIGURE 1

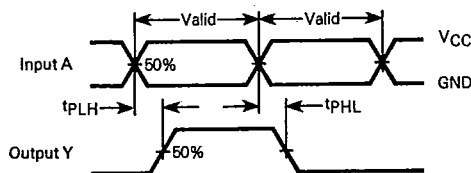


FIGURE 2

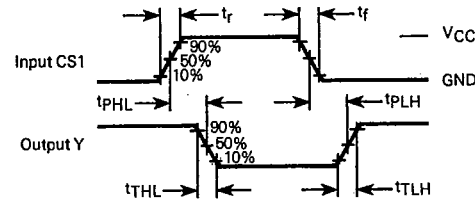


FIGURE 3

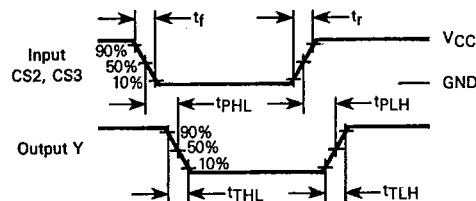
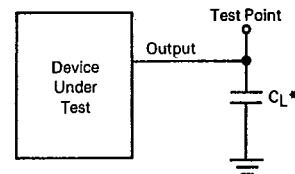


FIGURE 4 — TEST CIRCUIT



\* Includes all probe and jig capacitance.

## MC54/74HC138

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## PIN DESCRIPTIONS

## ADDRESS INPUTS

A0, A1, A2 (PINS 1, 2, 3) — Address inputs. These inputs, when the chip is selected, determine which of the eight outputs is active-low.

## CONTROL INPUTS

CS1, CS2, CS3 (PINS 6, 4, 5) — Chip select inputs. For CS1 at a high level and CS2, CS3 at a low level, the chip is selected and the

outputs follow the Address inputs. For any other combination of CS1, CS2, and CS3, the outputs are at a logic high.

## OUTPUTS

Y0-Y7 (PINS 15, 14, 13, 12, 11, 10, 9, 7) — Active-low Decoded outputs. These outputs assume a low level when addressed and the chip is selected. These outputs remain high when not addressed or the chip is not selected.

## EXPANDED LOGIC DIAGRAM

